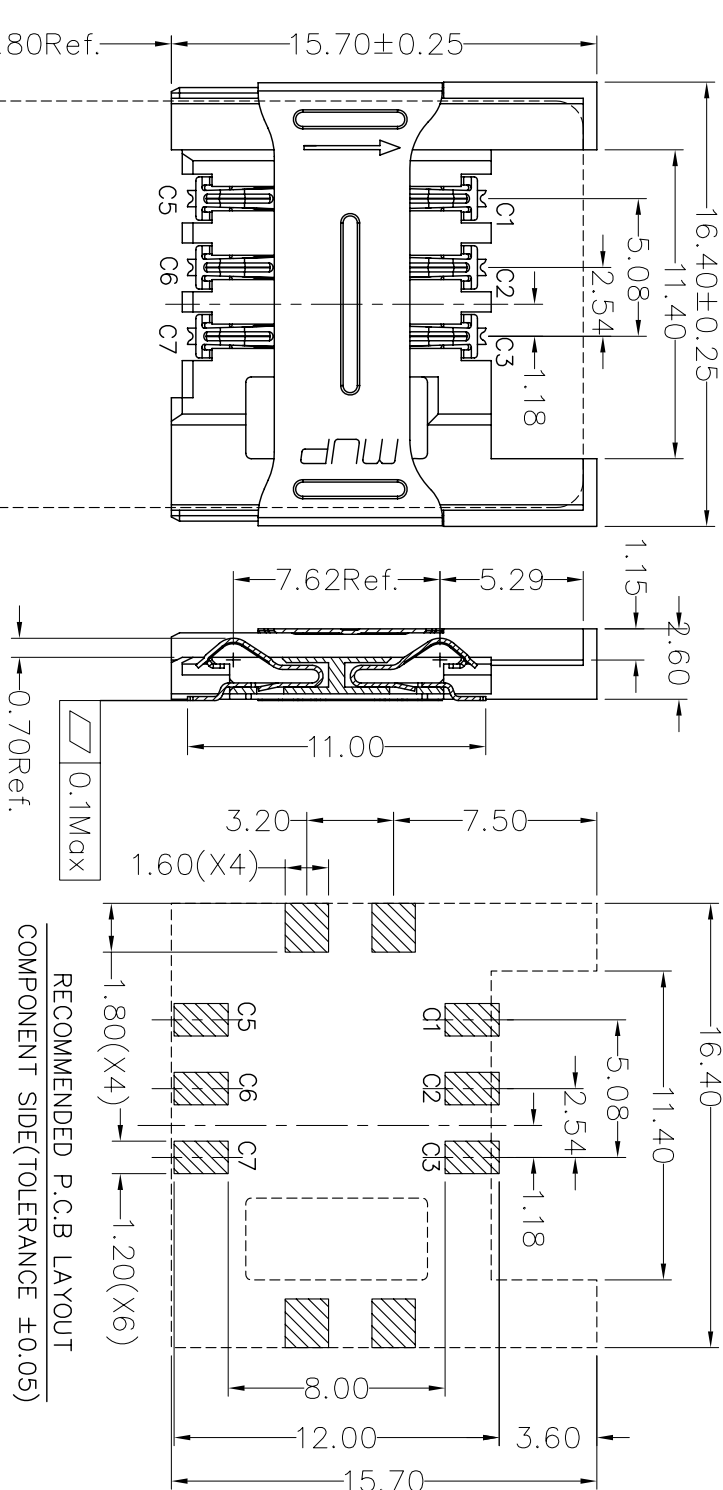


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE(TOLERANCE ±0.05)

TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 15.70LX16.40WX2.60H mm
Weight: Approx 0.52±0.2g
Durability: 5,000 cycles min.

2.Electrical Characteristics

Contact resistance: 50mΩ typical, 100mΩ max
Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vaporphase: 215°C, 30sec. Max
IR reflow: 250°C, 5sec. Max
Manual soldering: 370°C, 3sec. Max

4.Environmental Characteristics

Operating temperature: -40°C~+85°C
Operating humidity: 10%~+95%RH



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	LCP+30%GF	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area: Gold plated
3	SHELL	1	Stainless Steel	SMT area: Gold plated

Unless otherwise specified, other tolerance are:		MUP MUP INDUSTRIAL CO.,LTD.	
NAME: SIM Card Connector			
MODEL NO: MUP-C742			
TYPE : H2.60 (shorter tail)			
PROJ.	UNIT	SCALE	DWG NO.:
CUSTOMER DRAWING	mm	1:1	DWG-MUP-C742-002
CHECKED	Seon	Dec.07.2009	SHEET
APPROVAL	Jun	Dec.07.2009	1/1
			REVISION
			X1